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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of
Lee D. Whetsel

TI-20787.2

Serial No. 09/697,941

Art Unit: 2829

Filed: 10/26/2000

Examiner: Nguyen, Vinh P.

Title: Integrated Circuit Die With Bypass Bond Pad

Petition for Extension of Time Under 37 C.F.R. §1.136

September 16, 2003

Asst. Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(a)
I hereby certify that the above correspondence is
being deposited with the U.S. Postal Service as
First Class Mail in an envelope addressed to:
Assistant Commissioner For Patents, P.O. Box 1450
Alexandria, VA 22313-1450 on September 16, 2003.

Lawrence J. Bassuk, Reg. No. 29,043

Pursuant to 37 C.F.R. §1.136(a) applicant respectfully
petitions the Commissioner for an extension of the shortened
statutory period for response in this application.

The fee for this extension is indicated below:

- _____ One Month (\$110)
 x Two Months (\$410)
_____ Three Months (\$930)
_____ Four Months (\$1,450)

Please charge \$410.00 to Deposit Account No. 20-0668 of Texas
Instruments Incorporated. Any further necessary extension of time
is hereby requested. An original and a copy of this sheet are
enclosed.

Texas Instruments Incorporated
P.O. Box 655474 M/S 3999
Dallas, Texas 75265
(972) 917-5458
Fax: (972) 917-4418

Respectfully submitted,

Lawrence J. Bassuk
Reg. No. 29,043

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